

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Chip Type, High CV







- Chip type, higher capacitance in larger case sizes.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU).

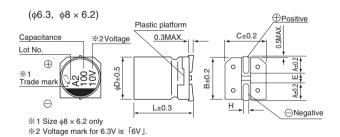




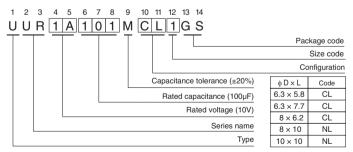
■ Specifications

Item	Performance Characteristics										
Category Temperature Range	−40 to +85°C										
Rated Voltage Range	4 to 100V										
Rated Capacitance Range	3.3 to 1500µF										
Capacitance Tolerance	±20% at 120Hz, 20°C										
Leakage Current	After 1 minute's application of rated voltage, leakage current is not more than 0.03CV (μA).										
									ement fr	requency: 12	0Hz at 20°C
Tangent of loss angle (tan δ)	0 ()	6.3	10	16		25	3		50	63	100
	tan δ (MAX.) 0.35).28	0.24	0.2	20	0.16	0.	4 0	.12	0.12	0.12
		_	Measurement frequ								
Stability at Low Temperature	Rated voltage (V)	4	6.3	10	_	16	25	35	50	63	100
Otability at Low Temperature	Impedance ratio Z-25°C / Z+20°C	7 15	5 10	8		3 6	2	3	3	3	2
	ZT / Z20 (MAX.) Z-40°C / Z+20°C	15	10	8	'	б	4	3	3	3	3
	The expedimentions listed at vight shall	Capacitance change Within				in ±20% of the initial capacitance value					
Endurance	The specifications listed at right shall the capacitors are restored to 20°C a	_	tan δ			200% or less than the initial specified value					
Endarance	voltage is applied for 2000 hours at 8	Leal	Leakage current			Less than or equal to the initial specified value					
	3 11										
Shelf Life	After storing the capacitors under no load at 85°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.										
	The capacitors are kept on a hot plat	1	Capacitance change Within ±10% of the initial ca					initial agaga	tanca valua		
Resistance to soldering	which is maintained at 250°C. The ca		tan δ Leakage current			ge Within ±10% of the initial capacitance value Less than or equal to the initial specified value					
heat	the characteristic requirements listed					Less than or equal to the initial specified value					
	are removed from the plate and resto	red to 20	· U.	L .							
Marking	Black print on the case top.										

■Chip Type



Type numbering system (Example: 10V 100µF)



$(\phi8\times10,\ \phi10)$	⊕ Paratition
Plastic platform Capacitance W2 Voltage L±0.5 Pressure relief vent	C±0.2 Positive

					(mm)
φD×L	6.3 × 5.8	6.3×7.7	8 × 6.2	8 × 10	10 × 10
Α	2.4	2.4	3.3	2.9	3.2
В	6.6	6.6	8.3	8.3	10.3
С	6.6	6.6	8.3	8.3	10.3
E	2.2	2.2	2.3	3.1	4.5
L	5.8	7.7	6.2	10	10
Н	0.5 to 0.8	0.5 to 0.8	0.5 to 0.8	0.8 to 1.1	0.8 to 1.1



■ Dimensions

	V		4	6	.3	1	0	1	16	2	25	3	5	5	0	6	3	10	00
Cap.(µF)	Code	0	G	C)J	1	Α	1	С	1	E	1	V	1	Н	1.	J	2.	A
3.3	3R3																	6.3×5.8	29
4.7	4R7														 	6.3×5.8	31	● 8×6.2	40 (35)
10	100								 - -		 				 	8 x 6.2	46	8×10	77
22	220													6.3×5.8	45	8 x 10	96	8×10	100
33	330											6.3×5.8	55	0 8×6.2	95 (94)	8 x 10	117	10×10	130
47	470									6.3×5.8	65	● 8×6.2	105 (94)	0 8 x 10	140 (105)	8 x 10	140	10×10	155
100	101					6.3×5.8	70	8×6.2	125	O 8×6.2	145 (143)	○ 8 x 10	175 (132)	■ 10×10	195 (181)	10 x 10	232		
150	151					6.3×5.8	85	6.3×7.7	151	8×10	192	8×10	214	10×10	238				
220	221			●8×6.2	160 (143)	○8×6.2	175 (173)	○8×10	215 (162)	■10×10	250 (232)	■10×10	265 (246)	10×10	289				
330	331	6.3×5.8	152	08x6.2	190 (188)	8×10	240	8×10	270	■10×10	305 (284)	10×10	324		 				
470	471	6.3×7.7	200	8×10	265	8×10	290	■10×10	330 (307)	10×10	393				 				
680	681	8×10	284	8×10	318	10×10	374	10×10	396										
1000	102	8×10	344	■10×10	400 (372)	10×10	454		i						i			Case size φD × L	Rated
1500	152	10×10	347	10×10	489													φυχι (mm)	ripple

Size ϕ 6.3 × 5.8 is available for capacitors marked. " • "
Size ϕ 6.3 × 7.7 is available for capacitors marked. " • "
Size ϕ 8 × 10 is available for capacitors marked. " ■ "

** In this case, (⑤) will be put at 12th digit of type numbering system.

Rated ripple current (mArms) at 85°C 120Hz

• Frequency coefficient of rated ripple current

Cap.(µF) Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Less than 47	0.80	1.00	1.15	1.40	1.67
100 to 1500	0.85	1.00	1.08	1.20	1.30

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please select UUG(p.156) if high CV products are required.
- Please refer to page 3 for the minimum order quantity.